



PV Crystalox Solar plc 2011 Interim Results 18 August 2011

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- Wafer shipments up 23% to 204MW (H1 2010: 165MW)
- Revenues up by 16% at €129.6m (H1 2010: €111.7m)
- EBIT up by 161% to €24.3m (H1 2010: €9.3m)
- Net cash position at 30 June 2011 of €41.3m (31 Dec 2010: €54.8m)

Strong H1 performance but continued expectation of difficult trading conditions in H2



Progress against Strategic Objectives

- Broadening geographical customer base with major PV companies
- Capacity increases on schedule and within budget
- 10% reduction in average wafer production cost in H1 2011
- Bitterfeld expected to operate at nameplate polysilicon production capacity in H2 2011





Financials



- Revenues at €129.6m (H1 2010: €111.7m)
- Volume growth outperformed price decline
 - Volume growth of 23%
 - ASP decline of 6%, accelerated in Q2
- EBIT (excluding currency movements) of €20.3m (H1 2010: €12.4m)
 - Currency gain of €3.7m (H1 2010: loss of €3.1m)
 - €4.4m inventory write down
- Earnings after tax €18.4m (H1 2010: €6.7m)
- No dividend declared
- Net cash of €43.1m at 30 June 2011 (31 Dec 2010: €54.8m)



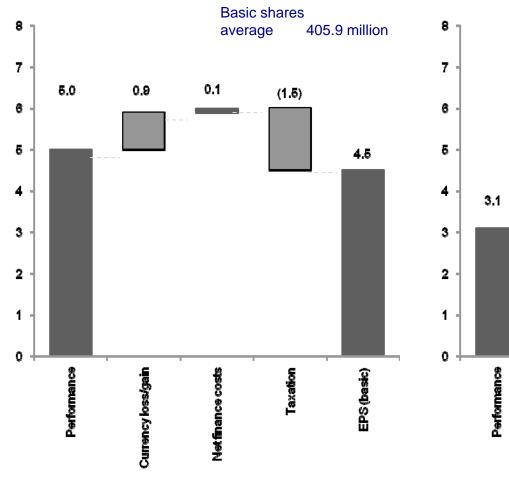
Statement of comprehensive income (€000) Half Year to 30 June 2011

(€000)	30-Jun-11	30-Jun-10	Change
Total Revenues	129,593	111,653	16.1%
EBIT excluding currency (losses)/gains	20,624	12,395	66.4%
Currency gains/(losses)	3,719	-3,083	
Earnings Before Interest & Tax (EBIT)	24,343	9,312	161.4%
Net interest income	262	143	83.2%
Earnings before taxation	24,605	9,455	160.2%
Taxation	-6,200	-2,803	121.2 %
NET INCOME	18,405	6,652	176.7%
Basic Earnings per share (Euro cents)	4.5	1.6	181.3%

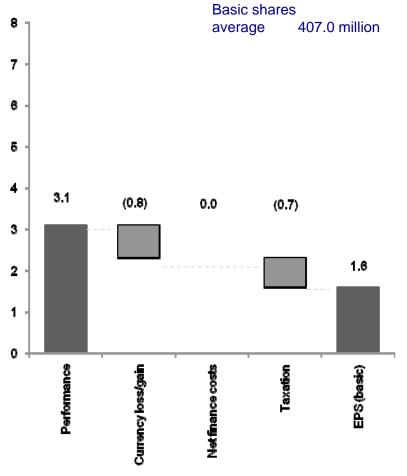
Drivers of EPS



H1 2011 (euro cents)



H1 2010 (euro cents)





(€m)	30-Jun-11	31-Dec-10
Current Assets	215.3	232.9
Non-current Assets	196.5	179.0
Total Assets	411.8 411	
Current Liabilities	106.9	95.4
Non-current Liabilities	24.0	35.7
Share Cap & Non-dist Reserves	76.2	76.0
Profit & Loss Reserves	204.7	204.8
Total Liabilities and Shareholder Equity	411.8	411.9

Summary cash flow & net cash/(debt) analysis **pv crystalox**



(€m)	30-Jun-11	30-Jun-10	30-Dec-10
Adjusted Earnings before tax	32.4	14.3	41.5
Tax paid	-7.1	-3.0	-7.8
Adjusted Earnings after tax	25.3	11.3	33.7
Changes in working capital	-7.6	-5.7	-23.5
Net cash flows in investing activities	-14.9	-2.3	-16.5
Free cash flow*	2.8	3.3	6.3
Net cash flows used in financing activities	-20.2	28.9	7.2
Net change in cash in period	-17.4	32.2	0.9
Cash and equivalents, start of year	101.3	100.4	100.4
Cash and equivalents, end of period	83.8	132.6	101.3
Group loans	-42.5	-55.5	-46.5
Cash / (net debt)	41.3	77.1	54.8

* Free cash flow defined as net cash from operating activities less cash used in investing less interest received





Strategy and Operational Review

Strategy

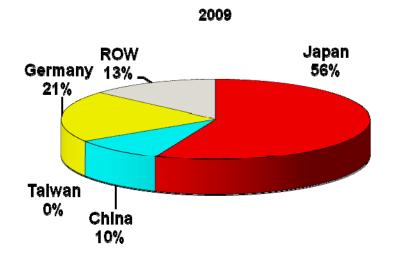


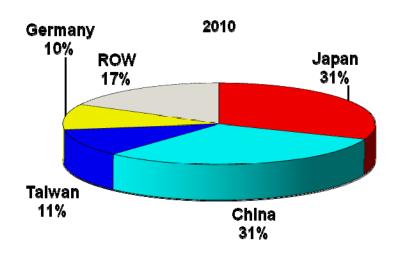
- Continued focus on operating cost reduction
 - Operating Bitterfeld polysilicon facility at full capacity
 - Production efficiencies
 - Higher yields
- Flexibility of production
 - diversity in sourcing polysilicon
 - optionality in wafering
- Continued focus on major PV companies
 - Diversifying customer base
 - Enhance relationship with existing customers
 - New customers in major markets Taiwan
- Further development of the leading silicon processing technology
 - Working with customers to increase product quality and develop next generation of wafer technology

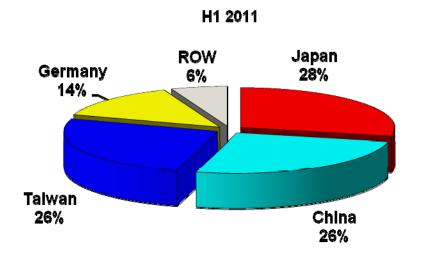
Strengthen position as a leading pure-play solar wafer manufacturer

Diversifying customer base









- Good progress in expanding and broadening geographical customer base
- Shipments to customers in Asia exceeded 80% of revenues
- Japan, Taiwan and China each account for in excess of 25% of revenues

Polysilicon production at Bitterfeld





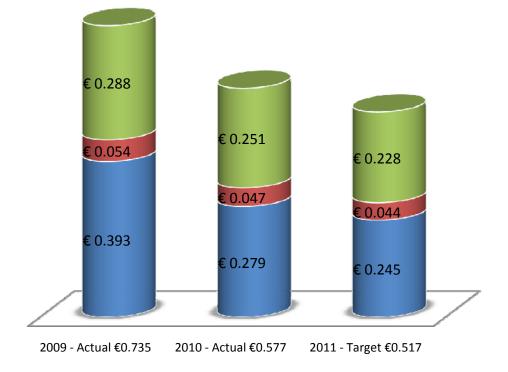
- Annualised output averaging 1475MT during the first five months of 2011, prior to scheduled maintenance shutdown in June
- Expected to operate at nameplate capacity of 1800MT during H2 2011
- Fully loaded production cost since August 2010 has been below the average price of our contracted polysilicon from external suppliers.
- Significant driver of future profitability





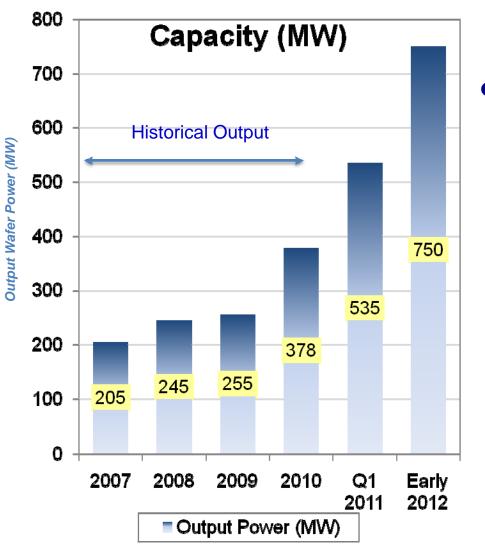
Blocking & Wafering	Ingot Production	Silicon Cost
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- 10% reduction in wafer cost in H1
- H1 2011 Actual 0.512/W, ahead of full year target
- Further 5% to 10% cost reduction expected in H2 2011



Production Capacity Increase





- Ingot production capacity increasing
 - Expansion to 535MW completed on schedule and within budget during Q1 2011
 - Next phase underway and will reach 750MW by early 2012



	430 MW to 535MW	535 MW to 750MW
	2010 – Q1 2011	2011- Early 2012
Ingot production	Y	Y
Blocking and wafering	Y	
Polysilicon plant	Y	
Estimated Total	€25m	€10m

- 535MW to 750MW ingot production only previously planned €30m including blocking and wafering
- Option for further capacity expansion to 1GW in 2013 remains under consideration.

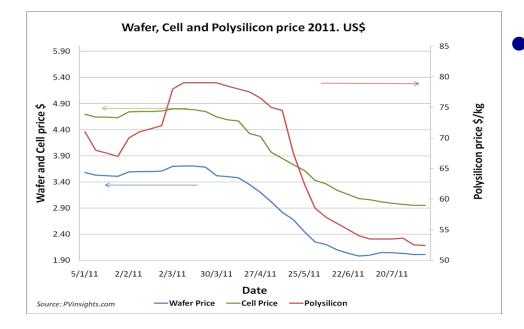




Global PV Market and Outlook

2011 Market Overview





• Measures being undertaken

- Accelerated cost reduction of 10% in H1
- Further production cost reductions planned for H2
 - Targeting a minimum further 5-10% reduction in 2011
 - Lower polysilicon cost from our internal production will be a key contributor
 - Negotiating price reductions with key suppliers

2011 Market conditions

- Weak H1 PV end market demand in key markets Germany and Italy
- Full year global installations still expected to be 19–21GW, compared to 6-7GW in H1
- High levels of inventory and weaker demand led to collapse in spot pricing across value chain late in H1
- Pricing pressure currently persisting



Challenging trading conditions

- FY global installations 19GW to 21GW
 - In advance of FIT cuts in 2012 in Germany and Italy
- Recent pricing pressures currently persisting
- PVCS expected 2011 output 400MW 450MW

Actions being taken

- Minimum 5% -10% cost reductions expected in H2 2011
 - Negotiating supplier price reductions
 - Lower wafering costs
 - Lower internal polysilicon costs

• Capacity expansion

- 750MW by early 2012
- expansion to 1GW remains under review

Medium Term

 Increased demand expected in a number of significant markets, particularly China, Japan and the US



- Strong performance in H1 despite difficult conditions
- Good progress against strategic objectives
- 45% reduction in wafer spot price in May and June
- Recent pricing pressures persisting
- Medium term developments in China, Japan and US, markets should assist in growth of the industry